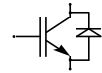


# Technische Information / Technical Information

IGBT-Module  
IGBT-Module

## BSM 150 GXL 120 DN2

eupec



### Höchstzulässige Werte / Maximum rated values

#### Elektrische Eigenschaften / Electrical properties

Kollektor-Emitter-Sperrspannung collector-emitter voltage		$V_{CES}$	1200	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ\text{C}$	$I_{C,nom.}$	150	A
	$T_C = 25^\circ\text{C}$	$I_C$	200	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$	$I_{CRM}$	300	A
Gesamt-Verlustleistung total power dissipation	$T_C=25^\circ\text{C}$ , Transistor	$P_{tot}$	1050	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V
Dauergleichstrom DC forward current		$I_F$	150	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	$I_{FRM}$	300	A
Grenzlastintegral der Diode $I^2t$ - value, Diode	$V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^\circ\text{C}$	$I^2t$	12	$\text{kA}^2\text{s}$
Isolations-Prüfspannung insulation test voltage	RMS, $f = 50\text{ Hz}, t = 1\text{ min.}$	$V_{ISOL}$	2,5	kV

### Charakteristische Werte / Characteristic values

#### Transistor / Transistor

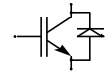
			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$I_C = 150\text{A}, V_{GE} = 15\text{V}, T_{vj} = 25^\circ\text{C}$	$V_{CE\text{ sat}}$	-	2,5	3	V
	$I_C = 150\text{A}, V_{GE} = 15\text{V}, T_{vj} = 125^\circ\text{C}$		-	3,1	3,7	V
Gate-Schwellenspannung gate threshold voltage	$I_C = 6\text{mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	$V_{GE(th)}$	4,5	5,5	6,5	V
Eingangskapazität input capacitance	$f = 1\text{MHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$	$C_{ies}$	-	10	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^\circ\text{C}$	$I_{CES}$	-	0,01	1	mA
	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}, T_{vj} = 125^\circ\text{C}$		-	8		mA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^\circ\text{C}$	$I_{GES}$	-	-	320	nA

prepared by: Mark Münzer

date of publication: 2003-12-09

approved by: Robert Severin

revision: 3.1



**Charakteristische Werte / Characteristic values**

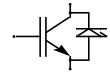
**Transistor / Transistor**

			min.	typ.	max.	
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	$I_C = 150A, V_{CE} = 600V$	$t_{d,on}$	-	0,07	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 125^\circ C$					
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 150A, V_{CE} = 600V$	$t_r$	-	0,05	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 125^\circ C$					
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	$I_C = 150A, V_{CE} = 600V$	$t_{d,off}$	-	0,45	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 125^\circ C$					
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 150A, V_{CE} = 600V$	$t_f$	-	0,034	-	$\mu s$
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 25^\circ C$					
	$V_{GE} = \pm 15V, R_G = 5,6\Omega, T_{vj} = 125^\circ C$					
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = 150A, V_{CE} = 600V, V_{GE} = 15V$ $R_G = 5,6\Omega, T_{vj} = 125^\circ C, L_S = 80nH$	$E_{on}$	-	24,4	-	mWs
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = 150A, V_{CE} = 600V, V_{GE} = 15V$ $R_G = 5,6\Omega, T_{vj} = 125^\circ C, L_S = 80nH$	$E_{off}$	-	12,7	-	mWs
Kurzschlußverhalten SC Data	$t_p \leq 10\mu sec, V_{GE} \leq 15V, R_G = 5,6\Omega$ $T_{vj} \leq 125^\circ C, V_{CC} = 720V, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	$I_{SC}$	-	1200	-	A
Modulinduktivität stray inductance module		$L_{sCE}$	-	35	-	nH

**Charakteristische Werte / Characteristic values**

**Diode / Diode**

			min.	typ.	max.	
Durchlaßspannung forward voltage	$I_F = 150A, V_{GE} = 0V, T_{vj} = 25^\circ C$	$V_F$	-	2,3	2,8	V
	$I_F = 150A, V_{GE} = 0V, T_{vj} = 125^\circ C$					
Rückstromspitze peak reverse recovery current	$I_F = 150A, -di_F/dt = 2500A/\mu sec$	$I_{RM}$	-	160	-	A
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					
Sperrverzögerungsladung recovered charge	$I_F = 150A, -di_F/dt = 2500A/\mu sec$	$Q_r$	-	13	-	$\mu As$
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					
Abschaltenergie pro Puls reverse recovery energy	$I_F = 150A, -di_F/dt = 2500A/\mu sec$	$E_{rec}$	-	3,1	-	mWs
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$					
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$					



**Thermische Eigenschaften / Thermal properties**

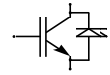
			min.	typ.	max.	
Innerer Wärmewiderstand thermal resistance, junction to case	Transistor / transistor, DC	$R_{thJC}$	-	-	0,12	K/W
	Diode/Diode, DC		-	-	0,28	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	pro Zweig / per arm $d_{paste} \leq 50\mu m / d_{grease} \leq 50\mu m$	$R_{thCK}$	-	-	0,012	K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj}$	-	-	150	°C
Betriebstemperatur operation temperature		$T_{op}$	-40	-	125	°C
Lagertemperatur storage temperature		$T_{stg}$	-40	-	125	°C

**Mechanische Eigenschaften / Mechanical properties**

Gehäuse, siehe Anlage case, see appendix					
Innere Isolation internal insulation				AlN	
Kriechstrecke creepage distance				20	mm
Luftstrecke clearance				11	mm
CTI comperative tracking index				225	
Anzugsdrehmoment f. mech. Befestigung mounting torque		M1	3	6	Nm
Anzugsdrehmoment f. elektr. Anschlüsse terminal connection torque	terminals M4	M2			Nm
	terminals M8				Nm
Gewicht weight		G		300	g

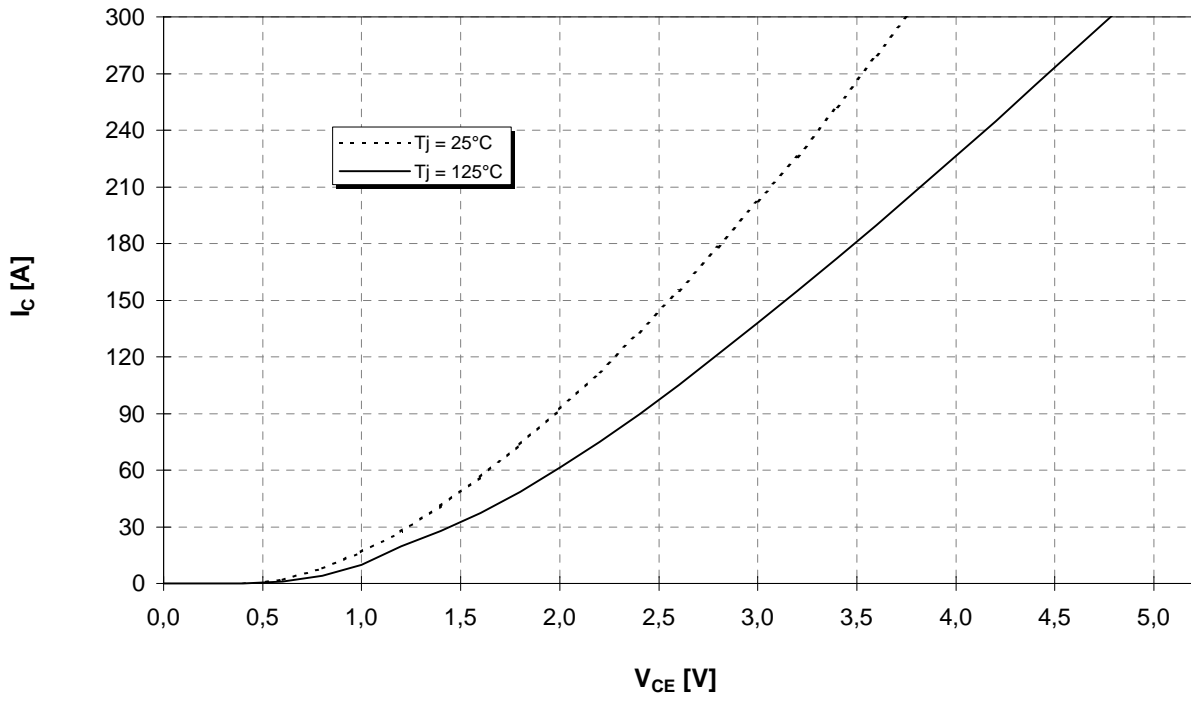
Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.



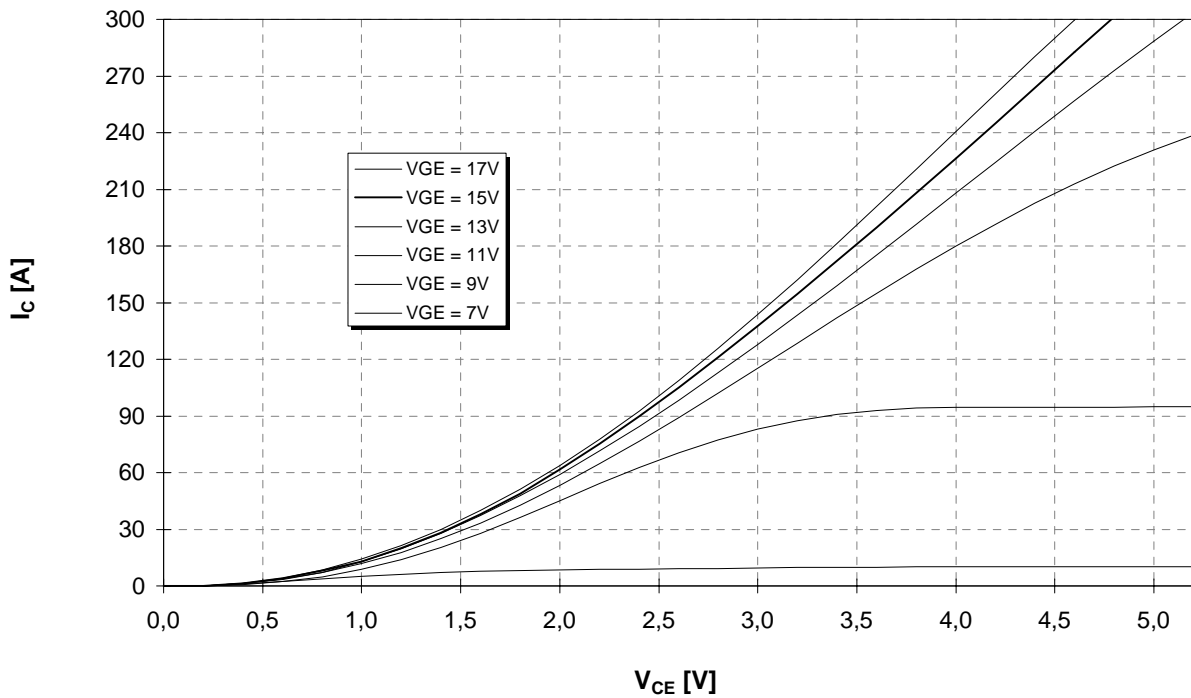
**Ausgangskennlinie (typisch)**  
**Output characteristic (typical)**

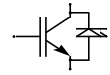
$I_c = f(V_{CE})$   
 $V_{GE} = 15V$



**Ausgangskennlinienfeld (typisch)**  
**Output characteristic (typical)**

$I_c = f(V_{CE})$   
 $T_{vj} = 125°C$

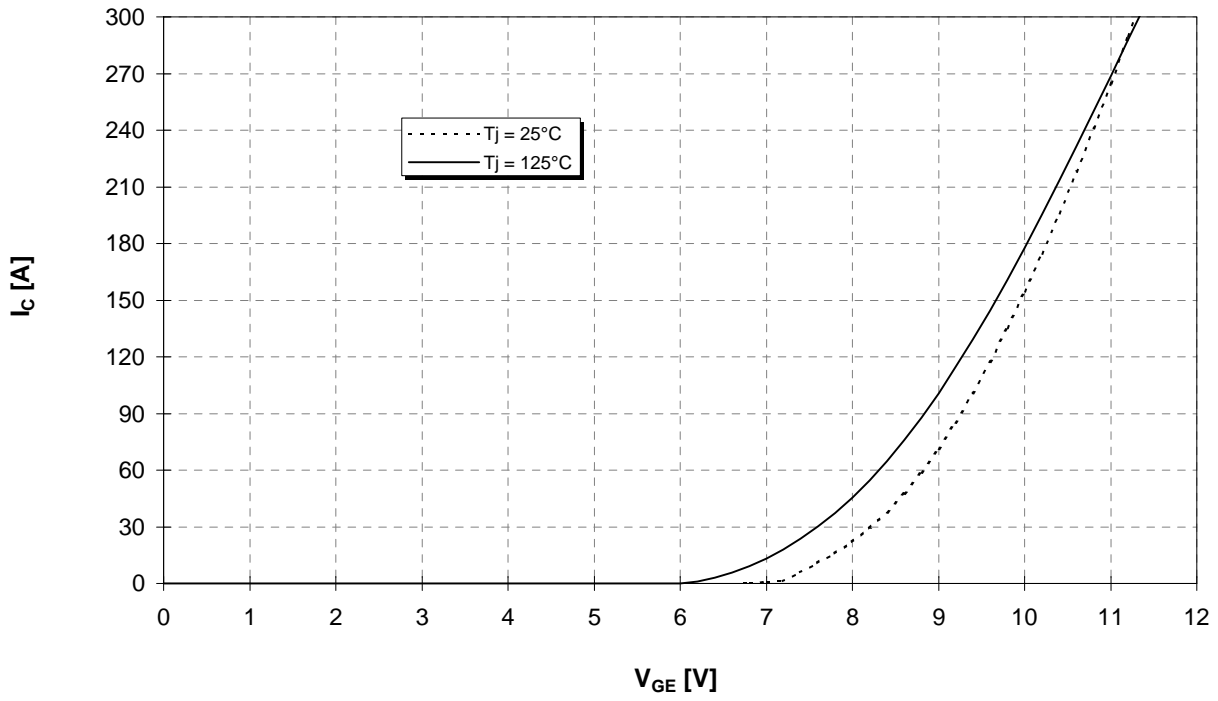




Übertragungscharakteristik (typisch)  
Transfer characteristic (typical)

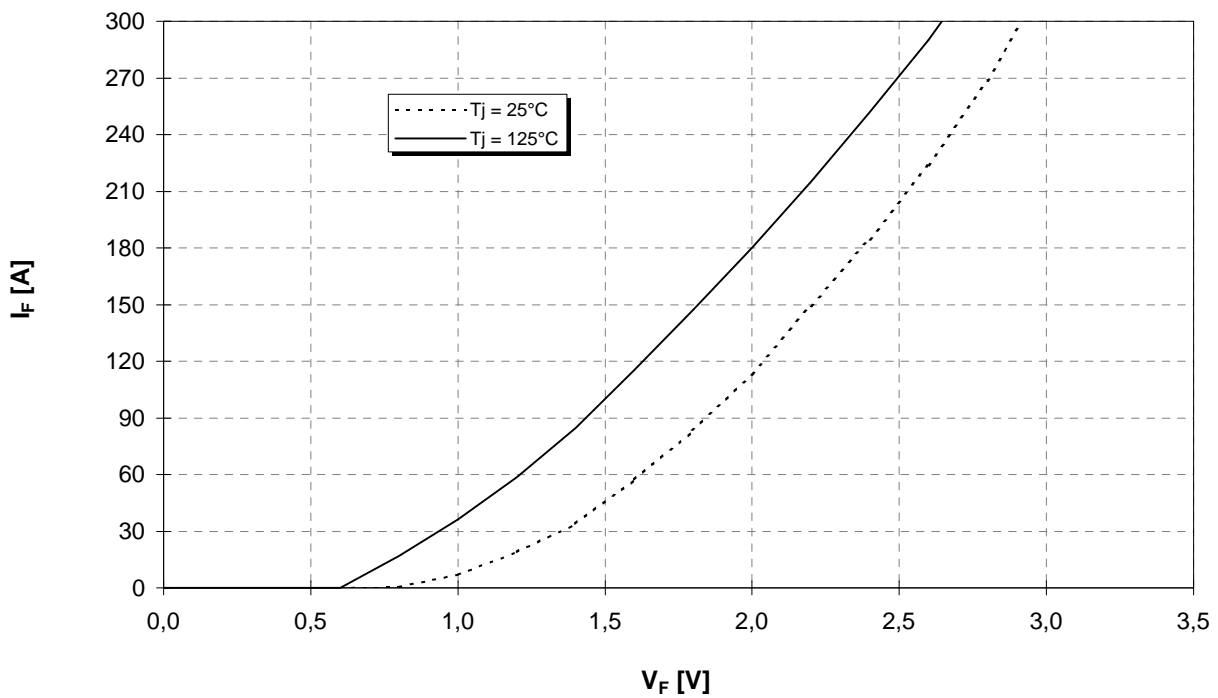
$$I_c = f(V_{GE})$$

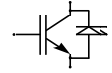
$V_{CE} = 20V$



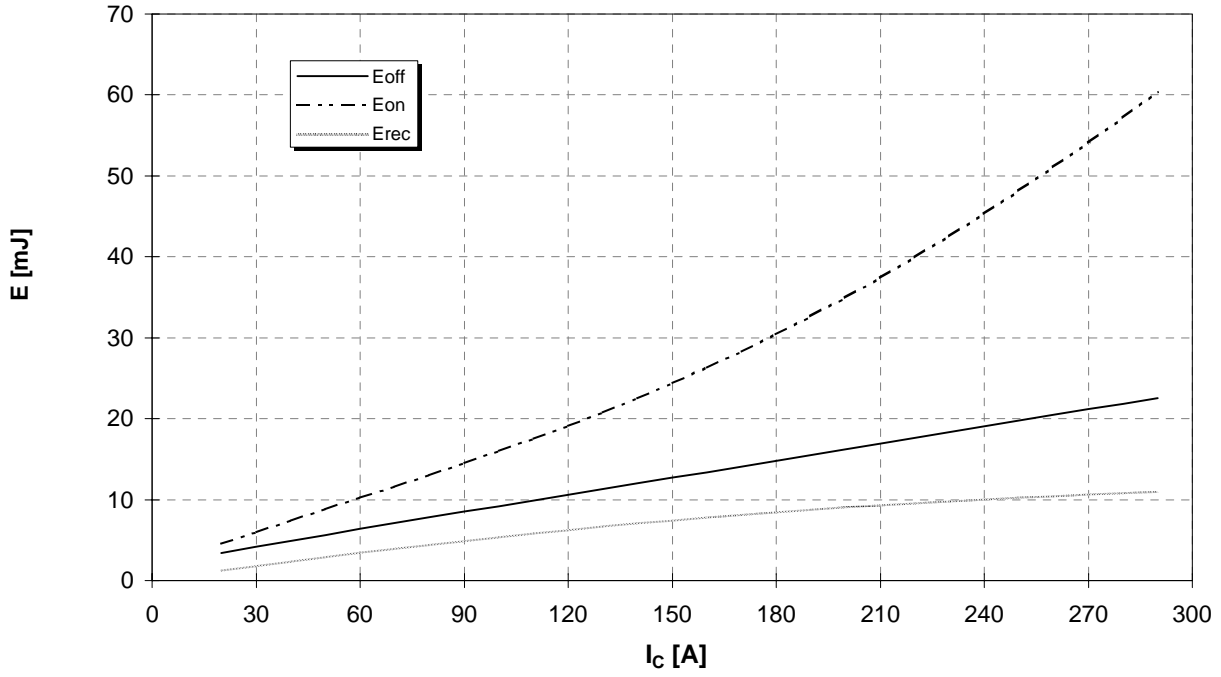
Durchlaßkennlinie der Inversdiode (typisch)  
Forward characteristic of inverse diode (typical)

$$I_F = f(V_F)$$

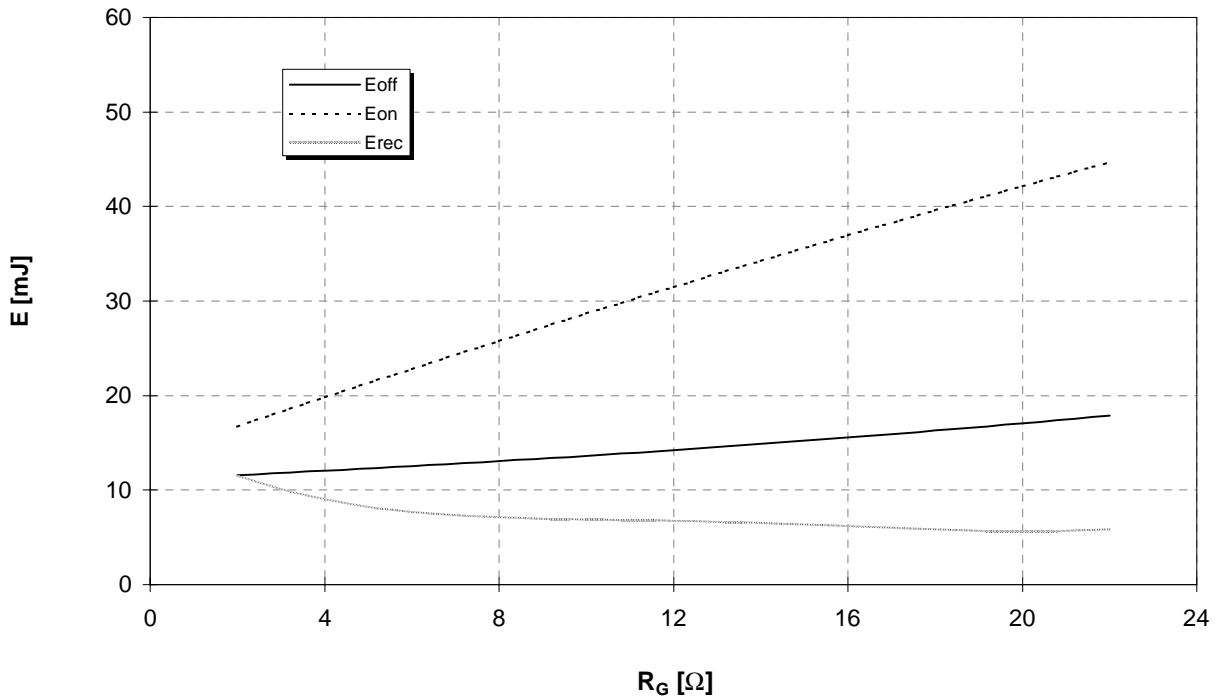


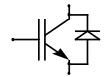


**Schaltverluste (typisch)  $E_{on} = f(I_C), E_{off} = f(I_C), E_{rec} = f(I_C)$**   
**Switching losses (typical)  $R_{gon} = R_{goff} = 5,6 \Omega, V_{CE} = 600V, T_j = 125^\circ C$**

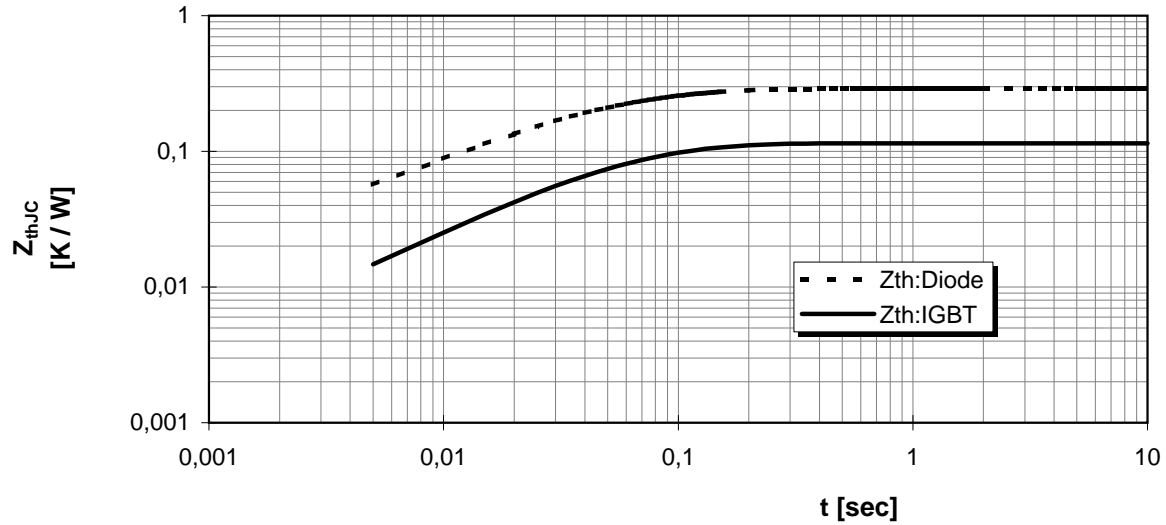


**Schaltverluste (typisch)  $E_{on} = f(R_G), E_{off} = f(R_G), E_{rec} = f(R_G)$**   
**Switching losses (typical)  $I_C = 150A, V_{CE} = 600V, T_j = 125^\circ C$**





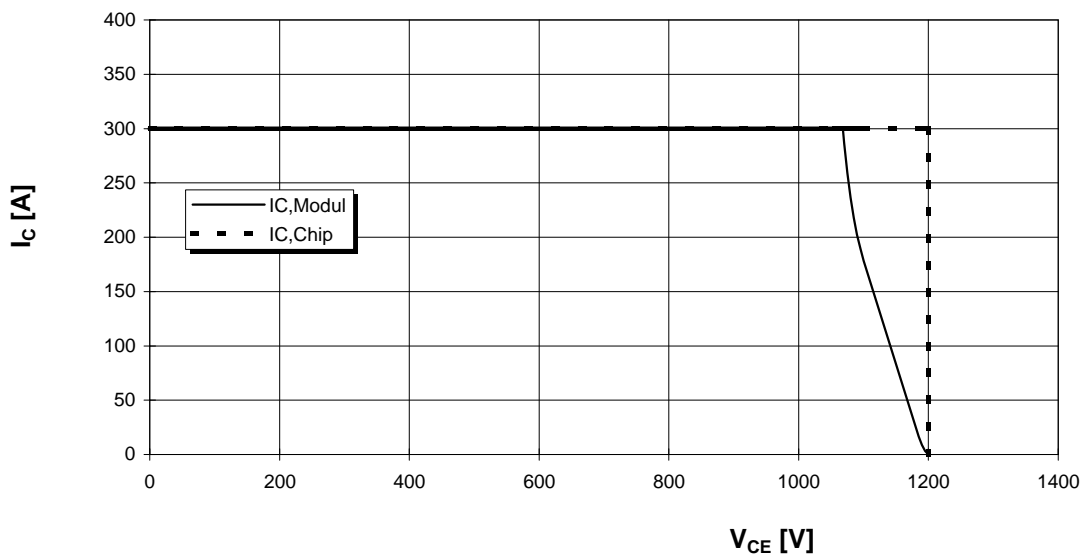
**Transienter Wärmewiderstand**  $Z_{thJC} = f(t)$   
**Transient thermal impedance**



i	1	2	3	4	5	6
$r_i$ [K/kW] : IGBT	0,00001	0,046308	0,053652	0,012162	0,002541	0,005278
$\tau_i$ [sec] : IGBT	277,9483	0,075179	0,0411	0,017635	0,002617	0,000562
$r_i$ [K/kW] : Diode	0,00001	0,153993	0,103323	0,00912	0,021627	0
$\tau_i$ [sec] : Diode	277,9483	0,06179	0,020533	0,01968	0,001761	0

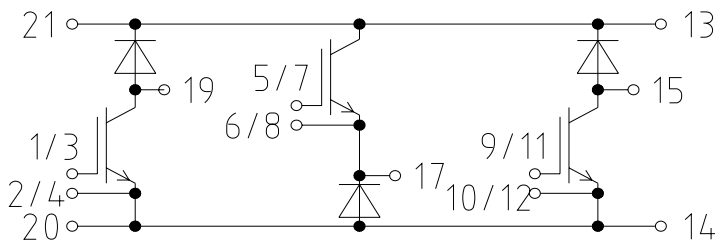
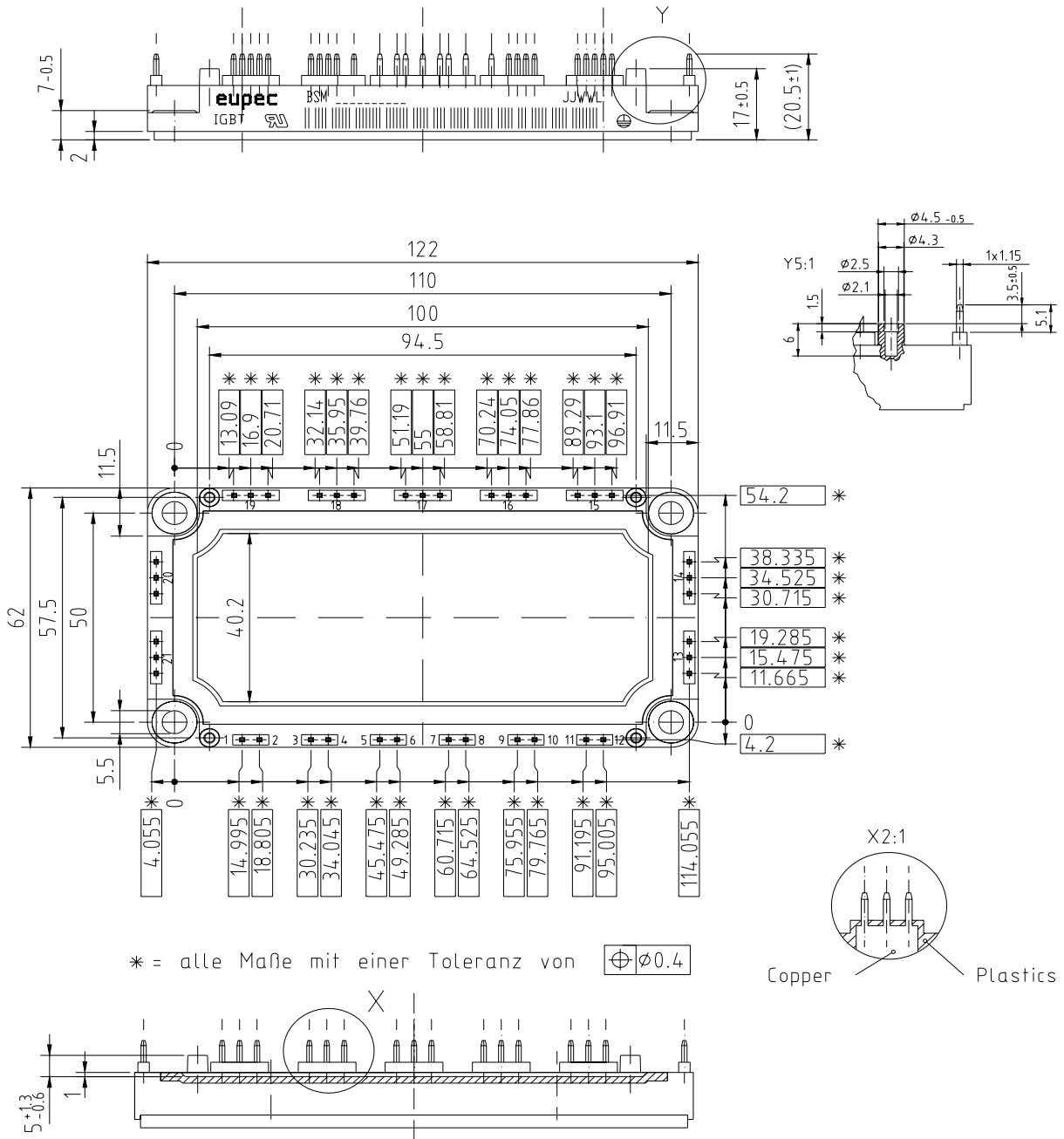
**Sicherer Arbeitsbereich (RBSOA)**

**Reverse bias safe operation area (RBSOA)**  $R_g = 5,6 \text{ Ohm}, T_{vj} = 125^\circ\text{C}$



IGBT-Module  
IGBT-Modules

## BSM150GXL120DN2



Pin 16 and 18 are not connected.

All gate pin's (1,3,5,7,9,11) and all auxiliary emitter pin's (2,4,6,8,10,12) must be connected !

## **Terms & Conditions of Usage**

### **Attention**

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